MBRS3100P

Surface Mount **Schottky Power Rectifier**

This device employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system.

Features

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guard-Ring for Stress Protection
- These are Pb-Free Packages

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 217 mg (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Cathode Polarity Band
- ESD Ratings:
 - Machine Model = C
 - ♦ Human Body Model = 3B



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SCHOTTKY BARRIER RECTIFIERS 3.0 AMPERES, 100 VOLTS



SMC CASE 403AC

MARKING DIAGRAM

AYWW B310•	þ
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B310 = Specific Device Code А

= Assembly Location

= Year

Υ

- WW = Work Week
 - = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
MBRS3100PT3G	SMC (Pb-Free)	2,500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	100	V
Average Rectified Forward Current (At Rated V_R , $T_L = 100^{\circ}C$)	I _{F(AV)}	3.0	A
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	130	A
Operating Junction Temperature Range (Note 1)	TJ	- 65 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. The heat generated must be less than the thermal conductivity from Junction–to–Ambient: $dP_D/dT_J < 1/R_{\theta JA}$.

THERMAL CHARACTERISTICS

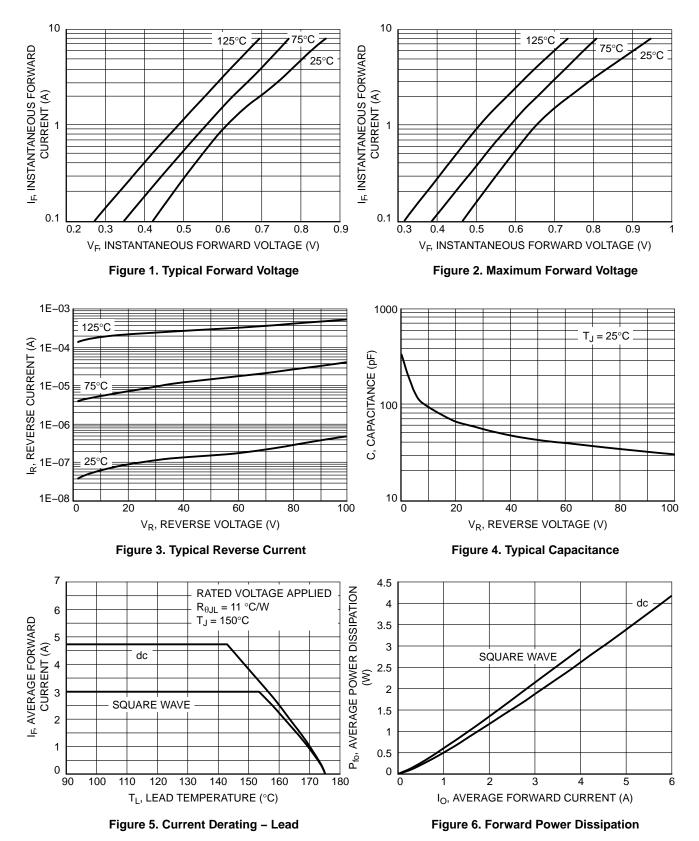
Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Lead	$R_{ ext{ heta}JL}$	11	°C/W

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
$ \begin{array}{l} \mbox{Maximum Instantaneous Forward Voltage (Note 2)} \\ (i_F = 3.0 \mbox{ A}, \mbox{ T}_J = 25^\circ \mbox{C}) \\ (i_F = 6.0 \mbox{ A}, \mbox{ T}_J = 25^\circ \mbox{C}) \\ (i_F = 3.0 \mbox{ A}, \mbox{ T}_J = 125^\circ \mbox{C}) \\ (i_F = 6.0 \mbox{ A}, \mbox{ T}_J = 125^\circ \mbox{C}) \end{array} $	V _F	0.79 0.90 0.62 0.70	V
Maximum Instantaneous Reverse Current (Note 2) (Rated dc Voltage, $T_J = 25^{\circ}C$) (Rated dc Voltage, $T_J = 125^{\circ}C$)	i _R	0.2 5.0	mA

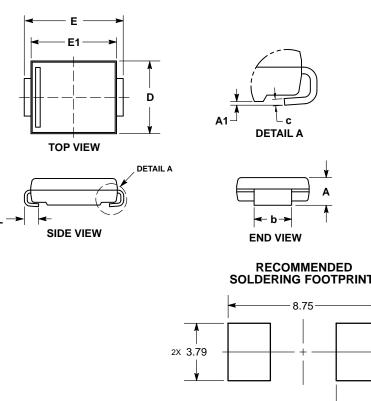
2. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.

MBRS3100P



PACKAGE DIMENSIONS

SMC 2-LEAD CASE 403AC ISSUE O



NOTES:

DIMENSIONING AND TOLERANCING PER ANME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH.

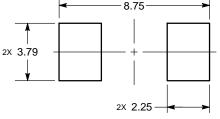
2.

3.

MOLD FLASH SHALL NOT EXCEED 0.13 PER SIDE. DIMENSIONS D AND E1 TO BE DETERMINED AT DATUM H. DIMENSION b SHALL BE MEASURED WITHIN THE AREA DE-5 TERMINED BY DIMENSION L.

	MILLIMETERS		
DIM	MIN	MAX	
Α	1.95	2.65	
A1	0.05	0.20	
b	2.90	3.20	
С	0.15	0.41	
D	5.55	6.25	
E	7.75	8.15	
E1	6.60	7.15	
L	0.75	1.60	

SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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